

PRODUCT SPECIFICATION

4.3" TFT LCD MODULE

MODEL: T043480272-A7MMN-022 Ver:1.0



< ◇> Preliminary Specification

< ◆> Finally Specification

CUSTOMER'S APPROVAL	
CUSTOMER :	
SIGNATURE:	DATE:

APPROVED BY	PM REVIEWED	PD REVIEWED	PREPARED BY

Revision History

Table of Contents

No.	Item	Page
1.	General Description.....	4
2.	Module Parameter.....	4
3.	Absolute Maximum Ratings.....	4
4.	DC Characteristics.....	5
5.	Backlight Characteristic.....	5
	5.1. Backlight Characteristics.....	5
	5.2. Backlighting circuit.....	5
6.	Optical Characteristics.....	6
	6.1. Optical Characteristics.....	6
	6.2. Definition of Response Time.....	6
	6.3. Definition of Contrast Ratio.....	7
	6.4. Definition of Viewing Angles.....	7
	6.5. Definition of Color Appearance.....	8
	6.6. Definition of Surface Luminance, Uniformity and Transmittance.....	8
7.	Block Diagram and Power Supply.....	9
8.	Interface Pins Definition.....	10
9.	AC Characteristics and RGB Input Timing.....	11
	9.1. AC Characteristics.....	11
	9.2. RGB input Timing.....	12
	9.3. POWER ON/OFF SEQUENCE.....	14
10.	Quality Assurance.....	16
	10.1. Purpose.....	16
	10.2. Standard for Quality Test.....	16
	10.3. Nonconforming Analysis & Disposition.....	16
	10.4. Agreement Items.....	16
	10.5. Standard of the Product Visual Inspection.....	16
	10.6. Inspection Specification.....	17
	10.7. Classification of Defects.....	22
	10.8. Identification/marking criteria.....	22
	10.9. Packing.....	22
11.	Reliability Specification.....	24
12.	Precautions and Warranty.....	25
	12.1. Safety.....	25
	12.2. Handling.....	25
	12.3. Storage.....	25
	12.4. Metal Pin (Apply to Products with Metal Pins).....	25
	12.5. Operation.....	26
	12.6. Static Electricity.....	26
	12.7. Limited Warranty.....	26
13.	Packaging.....	27
14.	Outline Drawing.....	28

1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	4.3"	
LCD type	MVA TFT	
Display Mode	Transmissive /Normally white	
Resolution	480 RGB x 272	Pixels
View Direction	Full viewing	Best Image
Module Outline	105.5(H) x 67.2 (V) x 2.95 (T) (Note1)	mm
Active Area	95.04(H) x 53.86(V)	mm
Pixel Pitch	198(H) x 198(V)	um
Pixel Arrangement	RGB Stripe	
Polarizer Surface Treatment	Anti-glare	
Display Colors	16M	
Interface	24-bit RGB interface	
Driver IC	ST7282	-
With or Without Touch Panel	Without	
Operating Temperature	-20~70	°C
Storage Temperature	-30~80	°C
Weight	(45)	g

Note 1: Exclusive hooks, posts , FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VDD	-0.3	4.6	V
Storage temperature	T _{STG}	-30	+80	°C
Operating temperature	T _{OP}	-20	+70	°C

Note 1: If Ta below 50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	VDD	3.0	3.3	3.6	V
Logic Low input voltage	V _{IL}	0	-	0.3*VDD	V
Logic High input voltage	V _{IH}	0.7*VDD	-	VDD	V
Logic Low output voltage	V _{OL}	0	-	0.4	V
Logic High output voltage	V _{OH}	VDD-0.4	-	VDD	V
Current Consumption All Black	I _{cc+ I_{IN}} Logic Analog	-	(25)	-	mA

5. Backlight Characteristic

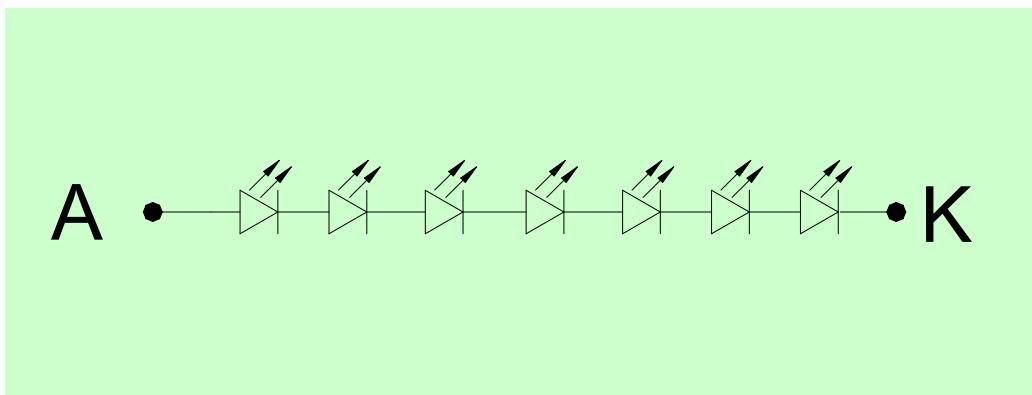
5.1. Backlight Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage	V _F	Ta=25 °C, I _F =20mA/LED	19.6	22.4	23.8	V
Forward Current	I _F	Ta=25 °C, V _F =3.2V/LED	-	20	-	mA
Power dissipation	P _D		-	448	-	mW
Uniformity	Avg		-	80	-	%
LED working life(25°C)	-		-	30,000	-	Hrs
Drive method	Constant current					
LED Configuration	7 White LEDs in serial					

Note1: LED life time defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at Ta=25±2 °C, 60%RH±5%, I_F=20mA

5.2. Backlighting circuit



6. Optical Characteristics

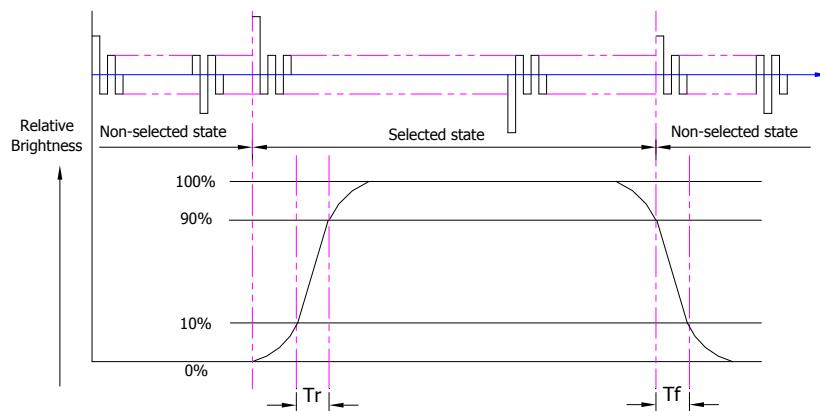
6.1. Optical Characteristics

Ta=25°C, VDD=3.3V

	Item	Symbol	Condition	Specification			Unit
				Min.	Typ.	Max.	
Backlight On (Transmissive Mode)	Luminance on TFT($I_f = 20\text{mA}/\text{LED}$)	L_V	Normally viewing angle $\theta_X = \varphi_Y = 0^\circ$	160	210	-	cd/m ²
	Contrast ratio(See 6.3)	CR		-	200	-	
	Response time (See 6.2)	T_R		-	25	50	ms
		T_F					
Chromaticity Transmissive (See 6.5)	Red	X_R	Center CR≥10	(0.532)	(0.582)	(0.632)	
		Y_R		(0.305)	(0.355)	(0.405)	
	Green	X_G		(0.272)	(0.322)	(0.372)	
		Y_G		(0.530)	(0.580)	(0.630)	
	Blue	X_B		(0.095)	(0.145)	(0.195)	
		Y_B		(0.011)	(0.061)	(0.111)	
	White	X_w		(0.246)	(0.296)	(0.346)	
		Y_w		(0.278)	(0.328)	(0.378)	
	Viewing Angle (See 6.4)	θ_{X+}		60	70	-	Deg.
		θ_{X-}		60	70	-	
		φ_{Y+}		60	70	-	
		φ_{Y-}		60	70	-	
	NTSC Ratio(Gamut)			40	50	-	%

6.2. Definition of Response Time

6.2.1. Normally Black Type (Negative)

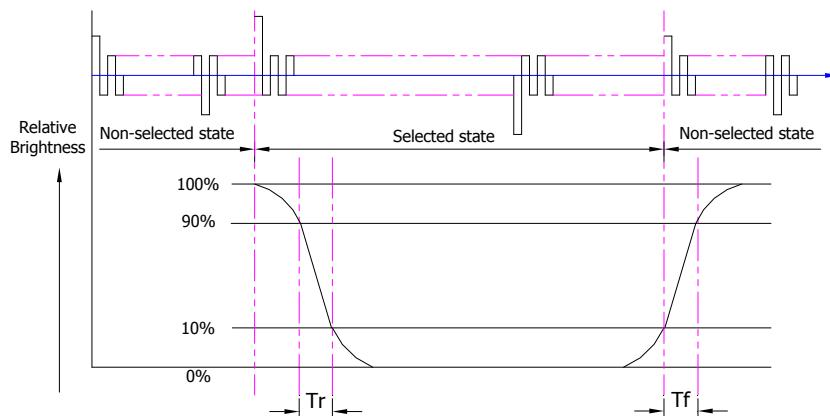


Tr is the time it takes to change from non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note : Measuring machine: LCD-5100

6.2.2. Normally White Type (Positive)



Tr is the time it takes to change from non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note : Measuring machine: LCD-5100 or EQUI

6.3. Definition of Contrast Ratio

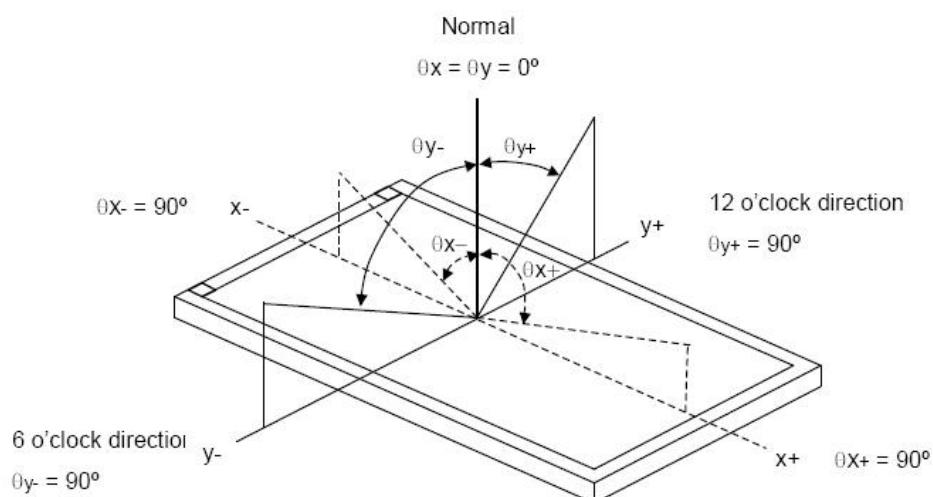
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Euivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

6.4. Definition of Viewing Angles



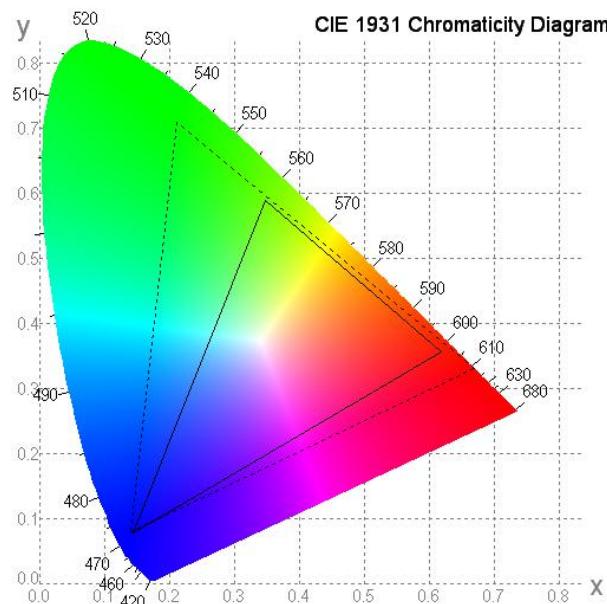
Measuring machine: LCD-5100 or EQUI

6.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)

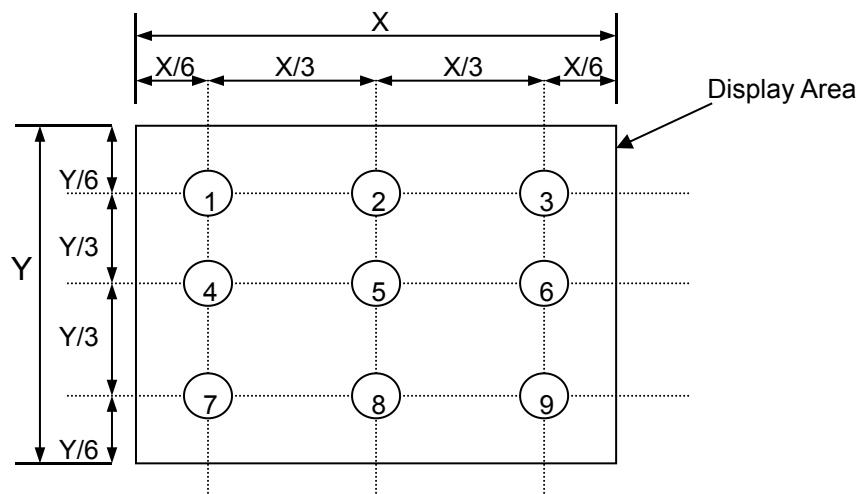


6.6. Definition of Surface Luminance, Uniformity and Transmittance

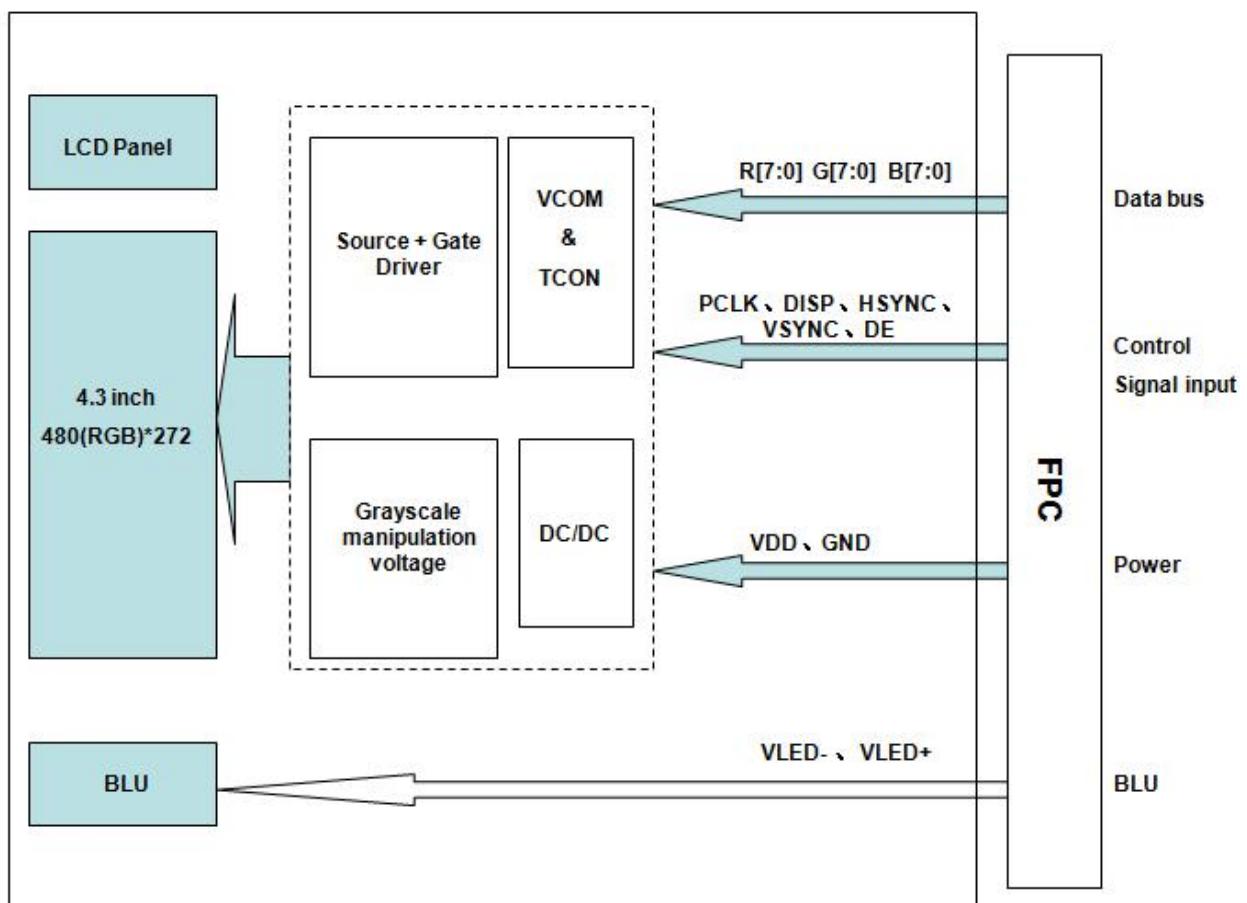
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

- 6.6.1. Surface Luminance: $L_v = \text{average } (L_{P1}:L_{P9})$
- 6.6.2. Uniformity = Minimal $(L_{P1}:L_{P9}) / \text{Maximal } (L_{P1}:L_{P9}) * 100\%$
- 6.6.3. Transmittance = $L_v \text{ on LCD} / L_v \text{ on Backlight} * 100\%$

Note : Measuring machine: BM-7



7. Block Diagram and Power Supply



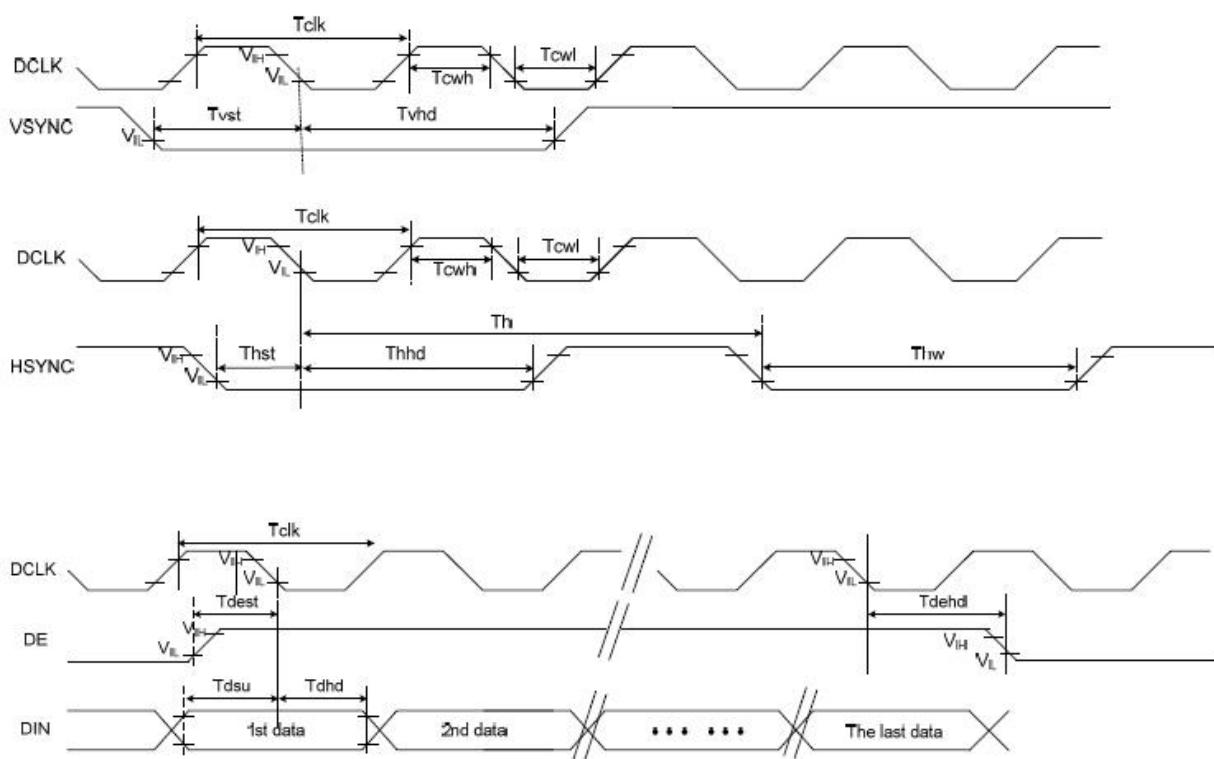
8. Interface Pins Definition

No.	Symbol	Function	Remark
1	VLED-	Backlight Cathode	
2	VLED+	Backlight Anode	
3	GND	Ground	
4	VDD	Power source	
5	R0	Red data signal	
6	R1	Red data signal	
7	R2	Red data signal	
8	R3	Red data signal	
9	R4	Red data signal	
10	R5	Red data signal	
11	R6	Red data signal	
12	R7	Red data signal	
13	G0	Green data signal	
14	G1	Green data signal	
15	G2	Green data signal	
16	G3	Green data signal	
17	G4	Green data signal	
18	G5	Green data signal	
19	G6	Green data signal	
20	G7	Green data signal	
21	B0	Blue data signal	
22	B1	Blue data signal	
23	B2	Blue data signal	
24	B3	Blue data signal	
25	B4	Blue data signal	
26	B5	Blue data signal	
27	B6	Blue data signal	
28	B7	Blue data signal	
29	GND	Ground	
30	PCLK	Clock signal to sample each data	
31	DISP	Display on/off signal DISP="H" Display on DISP="L" Display off	
32	Hsync	Horizontal synchronizing signal	
33	Vsync	Vertical synchronizing signal	
34	DE	Input data enable control.	
35	NC	No connection	
36	GND	Ground	
37-40	NC	No connection	

9. AC Characteristics and RGB Input Timing

9.1. AC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Conditions
System operation timing						
VDD power source slew time	TPOR	-	-	20	ms	From 0V to 99% VDD
GRB pulse width	tRSTW	10	50	-	us	R=10Kohm, C=1uF
Input/ Output timing						
CLK pulse duty	Tcw	40	50	60	%	
Hsync width	Thw	1	-	-	DCLK	
Hsync period	Th	55	60	65	us	
Vsync setup time	Tvst	12	-	-	ns	
Vsync hold time	Tvh	12	-	-	ns	
Hsync setup time	Thst	12	-	-	ns	
Hsync hold time	Thhd	12	-	-	ns	
Data setup time	Tdsu	12	-	-	ns	
Data hold time	Tdhd	12	-	-	ns	
DE setup time	Tdest	10	-	-	ns	
DE setup time	Tdehd	10	-	-	ns	
SD output stable time	Tst	-	-	12	us	Output settled within +20mV Loading = 6.8k+28.2pF.
GD output rise and fall time	Tgst	-	-	6	us	Output settled (5%~95%), Loading = 4.7k+29.8pF



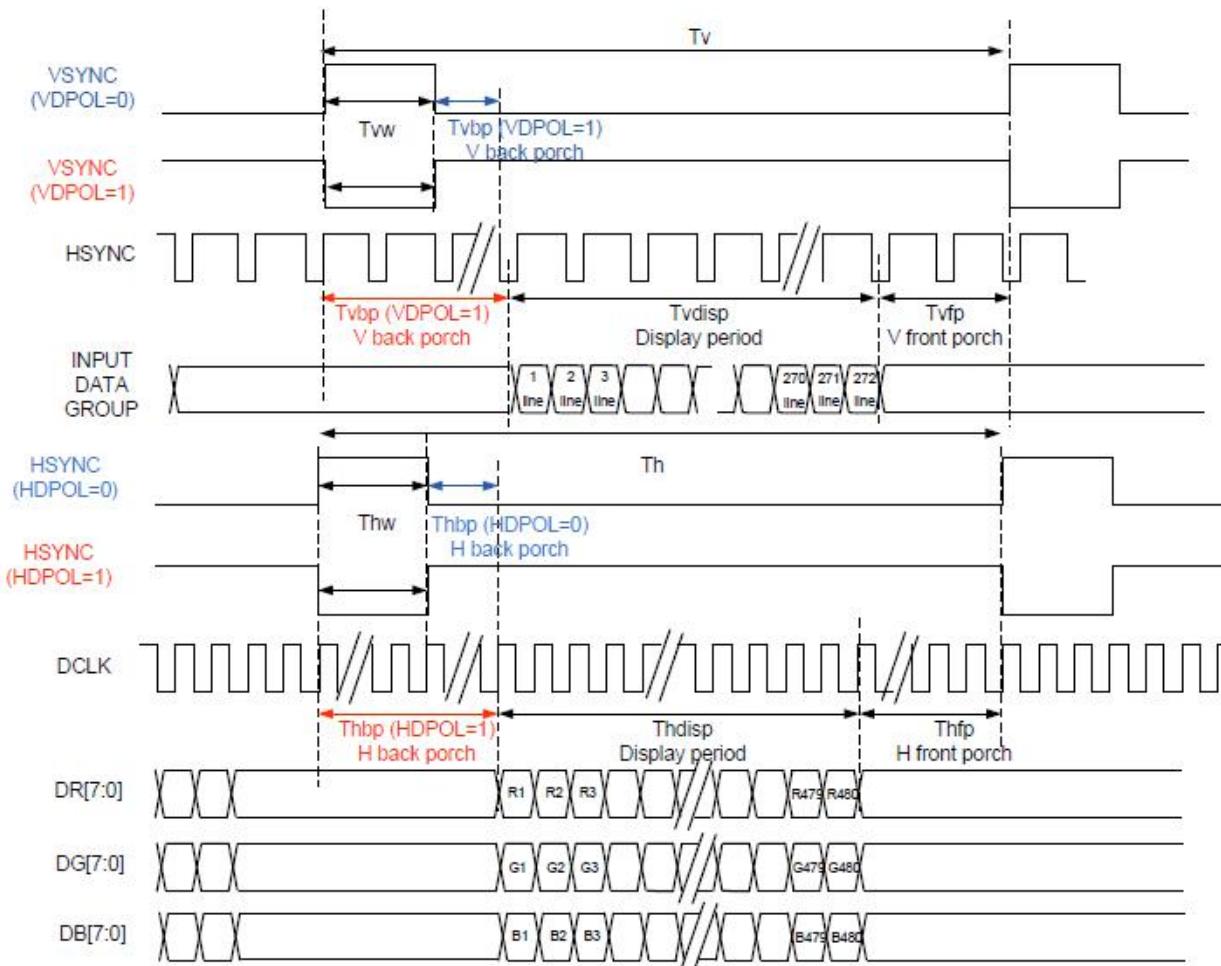
9.2. RGB input Timing

1) Parallel 24-bit RGB Timing Table

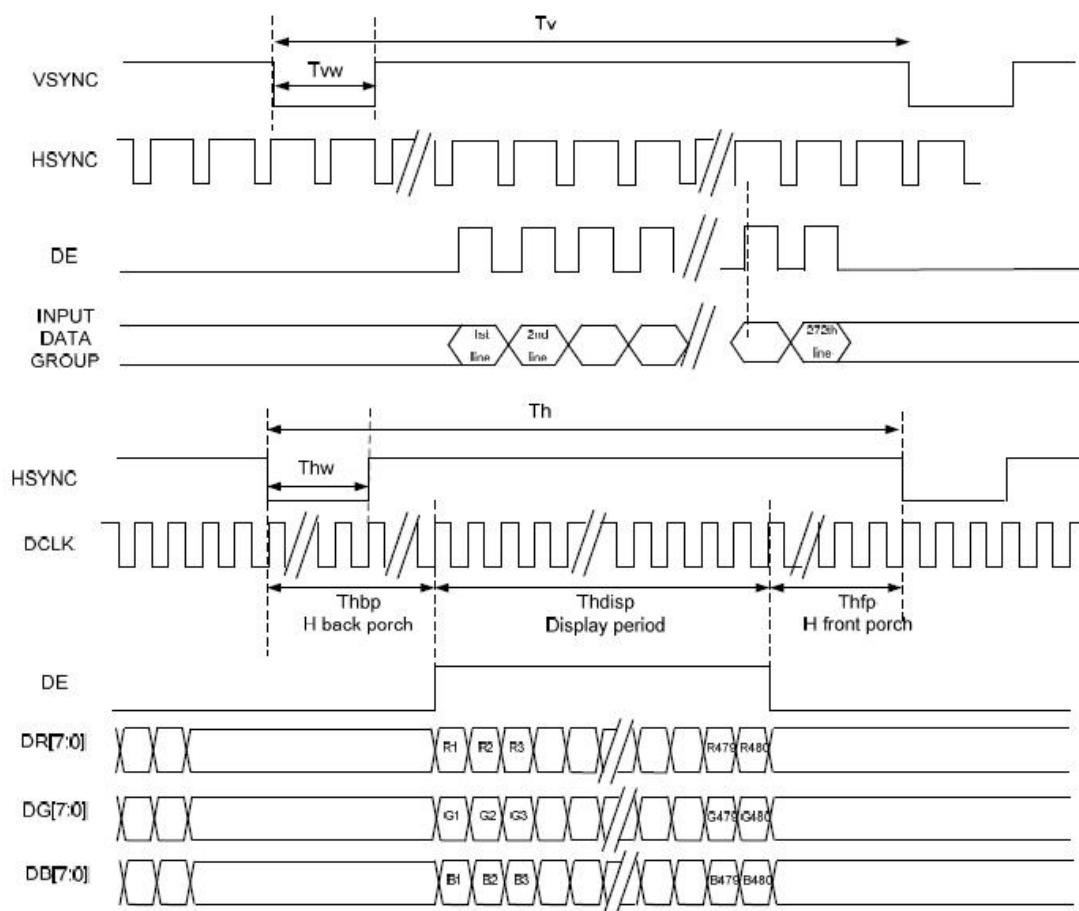
Item		Symbol	Min.	Typ.	Max.	Unit	Remark
DCLK Frequency		Fclk	8	9	12	MHz	
DCLK Period		Tclk	83	111	125	ns	
Hsync	Period Time	Th	485	531	598	DCLK	
	Display Period	Thdisp		480		DCLK	
	Back Porch	Thbp	3	43	43	DCLK	By H_Blanking setting
	Front Porch	Thfp	2	8	75	DCLK	
	Pulse Width	Thw	2	4	75	DCLK	
Vsync	Period Time	Tv	276	292	321	H	
	Display Period	Tvdisp		272		H	
	Back Porch	Tvbp	2	12	12	H	By V_Blanking setting
	Front Porch	Tvfp	2	8	37	H	
	Pulse Width	Tvw	2	4	37	H	

Note: It is necessary to keep $Tvbp = 12$ and $Thbp = 43$ in sync mode. DE mode is unnecessary to keep it.

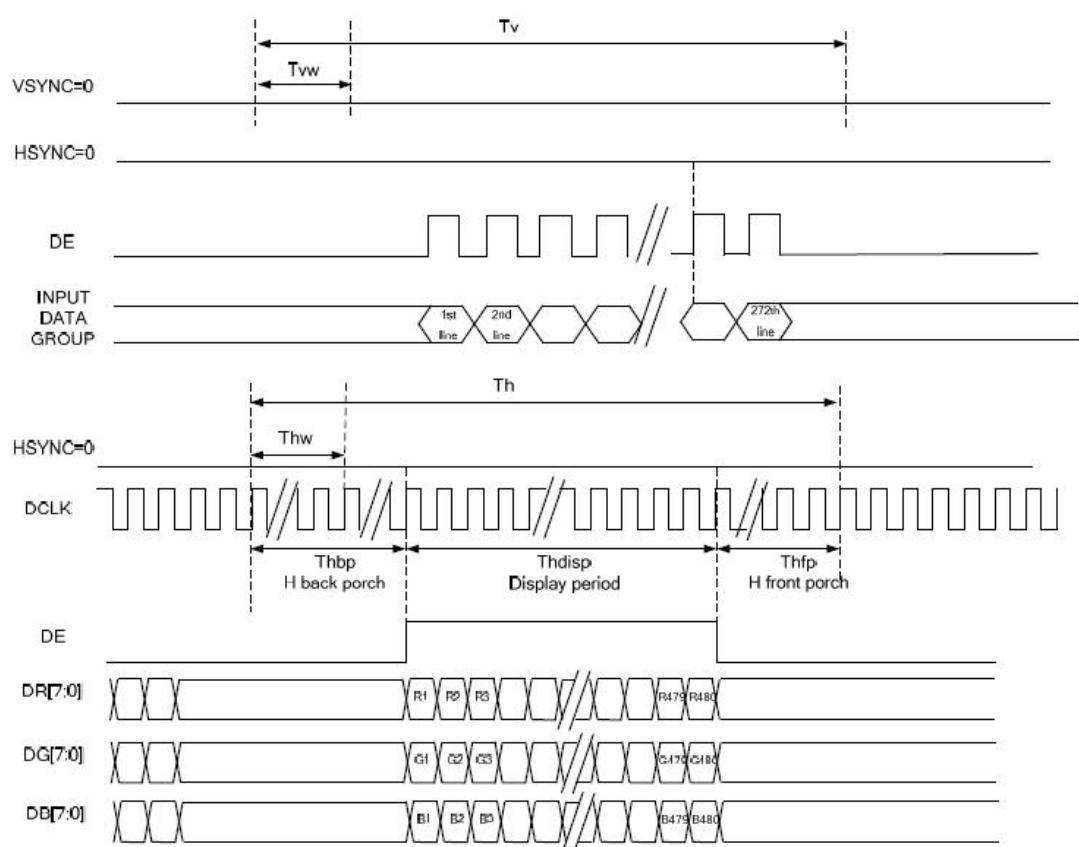
2) SYNC Mode Timing



3) SYNC-DE Mode Timing Diagram

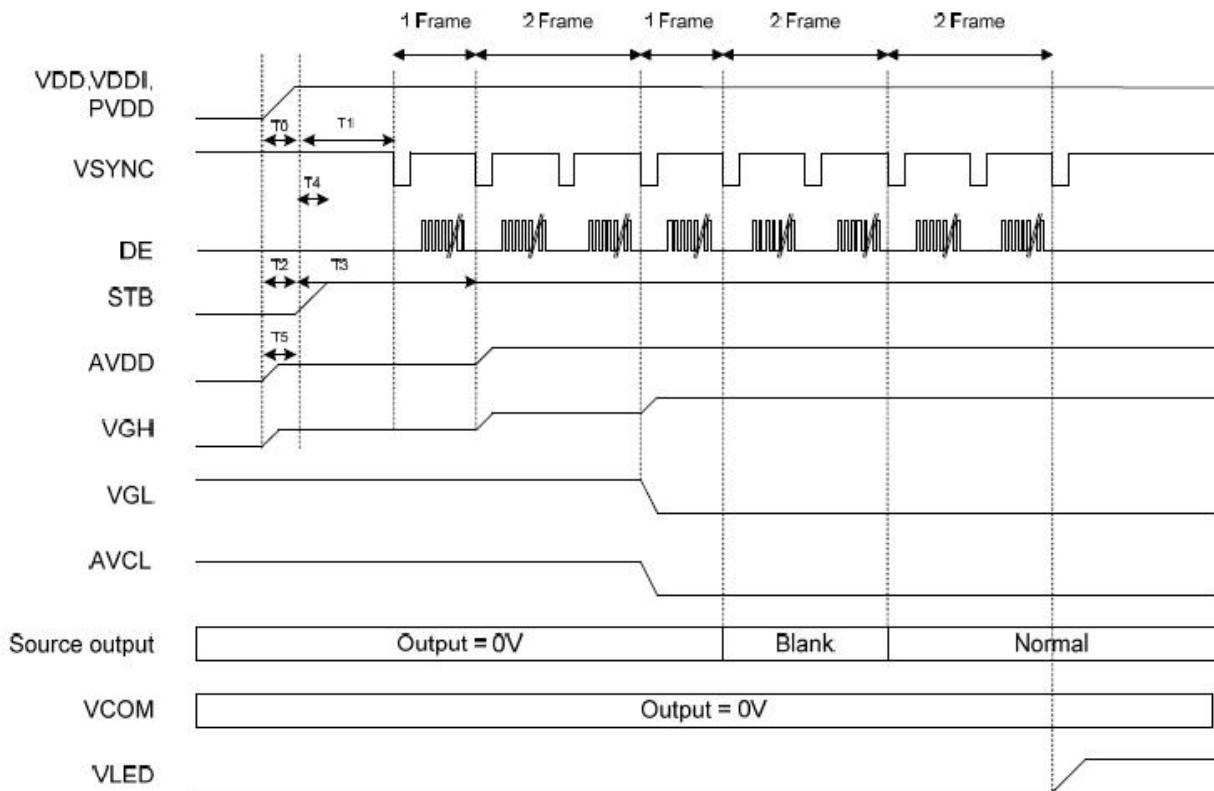


4) DE Mode Timing Diagram



9.3. POWER ON/OFF SEQUENCE

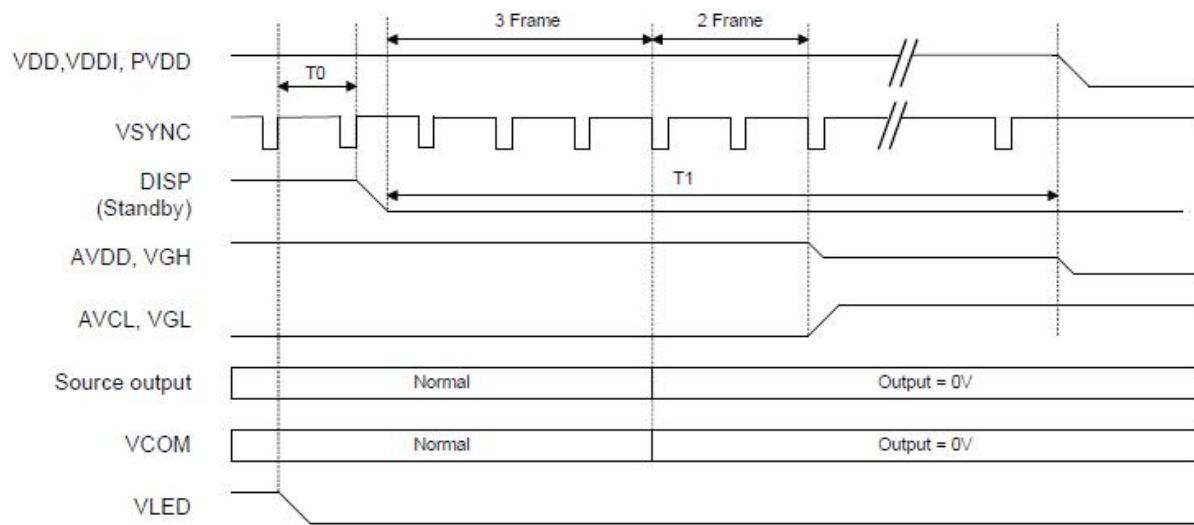
1) Power On Sequence



	Description	Min. Time
T0	Determined by the external power	
T1	Time from stable VDD, VDDI, PVDD set-up to the first VSYNC	T1=T0
T2	Time from AVDD=0V to AVDD=3.3V	T2=T0
T3	Time from AVDD=3.3V to AVDD=6.0V	T3=T1+ (1*Frame)
T4	Time from stable VDD, VDDI, PVDD set-up to DISP asserted	T4=0
T5	Time from VGH=0V to VGH=3.3V	T5=T0

Note: Recommend the LCM power on rise time T0= 0~ 1ms

2) Power Off Sequence



	Description	Min. Time
T0	Time from backlight power off to DISP='L'	1*Frame
T1	Time from DISP='L' to LCM Power off	5*Frame

10. Quality Assurance

10.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

10.2.Standard for Quality Test

10.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

10.2.2. Sampling Criteria:

Visual inspection: AQL 1.5%

Electrical functional: AQL 0.65%.

10.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

10.3.Nonconforming Analysis & Disposition

10.3.1. Nonconforming analysis:

10.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

10.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

10.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

10.3.2. Disposition of nonconforming:

10.3.2.1. Non-conforming product over PPM level will be replaced.

10.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

10.4.Agreement Items

Shall negotiate with customer if the following situation occurs:

10.4.1. There is any discrepancy in standard of quality assurance.

10.4.2. Additional requirement to be added in product specification.

10.4.3. Any other special problem.

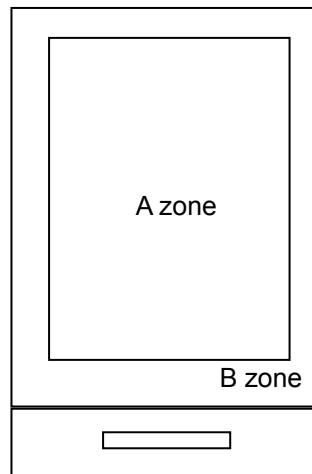
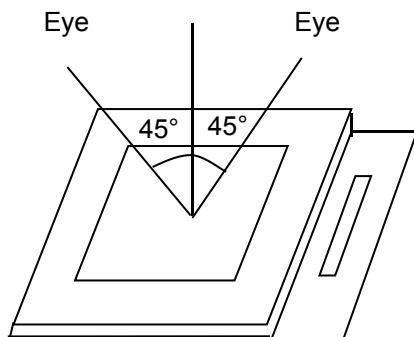
10.5.Standard of the Product Visual Inspection

10.5.1. Appearance inspection:

10.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

10.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

10.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,

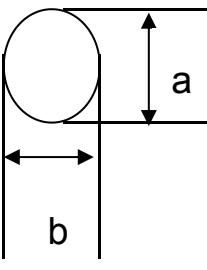


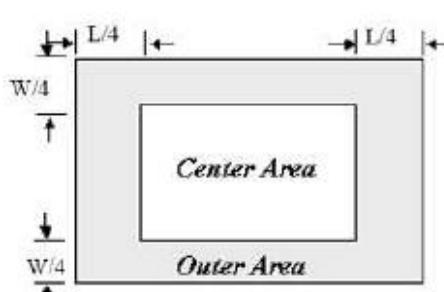
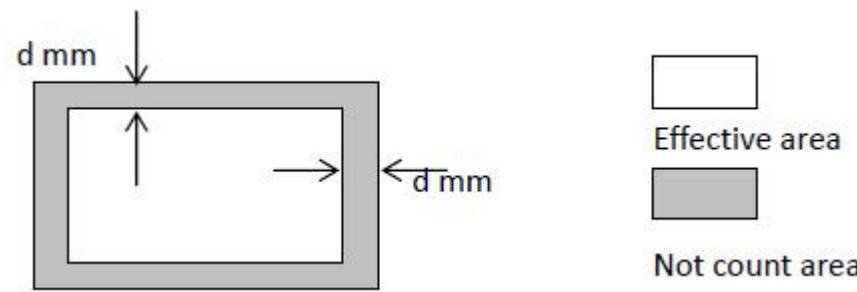
10.5.2. Basic principle:

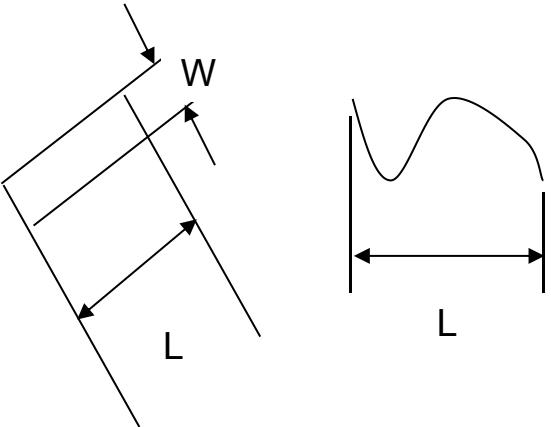
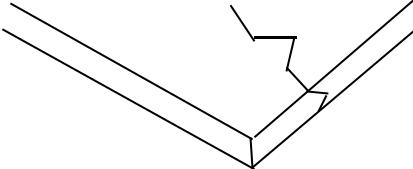
10.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

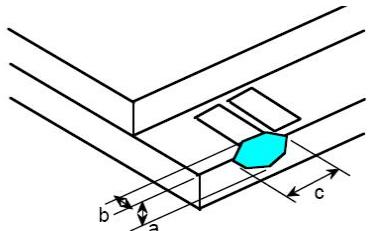
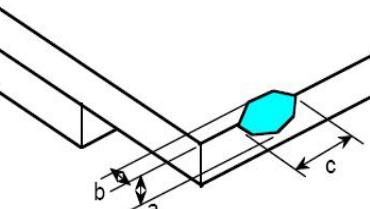
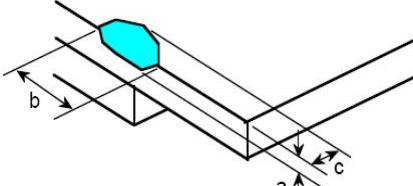
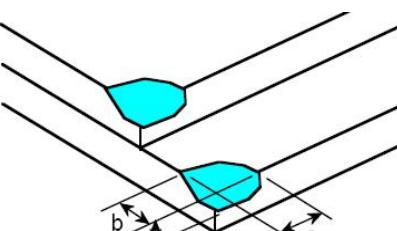
10.5.2.2. New item must be added on time when it is necessary.

10.6. Inspection Specification

No.	Item	Criteria (Unit: mm)													
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	 $\varphi = (a + b) / 2$	<table border="1"> <thead> <tr> <th>Area Size</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>$\varphi \leq 0.10$</td><td>Ignore</td></tr> <tr> <td>$0.10 < \varphi \leq 0.15$</td><td>2</td></tr> <tr> <td>$0.15 < \varphi \leq 0.25$</td><td>1</td></tr> <tr> <td>$0.25 < \varphi$</td><td>0</td></tr> <tr> <td>Total</td><td>2 no include $\varphi \leq 0.10$</td></tr> </tbody> </table>	Area Size	Acc. Qty	$\varphi \leq 0.10$	Ignore	$0.10 < \varphi \leq 0.15$	2	$0.15 < \varphi \leq 0.25$	1	$0.25 < \varphi$	0	Total	2 no include $\varphi \leq 0.10$
Area Size	Acc. Qty														
$\varphi \leq 0.10$	Ignore														
$0.10 < \varphi \leq 0.15$	2														
$0.15 < \varphi \leq 0.25$	1														
$0.25 < \varphi$	0														
Total	2 no include $\varphi \leq 0.10$														
Distance between 2 defects should more than 3mm apart.															
02	Electrical Defect (Minor defect)	<table border="1"> <thead> <tr> <th></th><th>Display Area</th><th>Total</th><th rowspan="4">Note 1</th></tr> </thead> <tbody> <tr> <td>Bright dot</td><td>0</td><td>0</td></tr> <tr> <td>Dark dot</td><td>$N \leq 2$</td><td>$N \leq 2$</td></tr> <tr> <td>Total dot</td><td>$N \leq 2$</td><td>$N \leq 2$</td></tr> </tbody> </table> <p>Mura Not visible through 5% ND filters. Note 2</p> <p>Remark:</p> <p>1. Bright dot caused by scratch and foreign object accords to item 1.</p>		Display Area	Total	Note 1	Bright dot	0	0	Dark dot	$N \leq 2$	$N \leq 2$	Total dot	$N \leq 2$	$N \leq 2$
	Display Area	Total	Note 1												
Bright dot	0	0													
Dark dot	$N \leq 2$	$N \leq 2$													
Total dot	$N \leq 2$	$N \leq 2$													

		<p>Line Criteria: $L \leq 1\text{mm}$, $W \leq 0.1\text{mm}$, Dot Criteria: Please refer to Note 1,2&3 Note1: Definition of Area</p> 																																				
03	Inactive Area (Minor defect)	<p>Note2:</p> <table border="1"> <thead> <tr> <th>尺寸</th> <th>缺圖</th> <th>中心 Center</th> <th>外圍 Outer</th> <th>總數 Total</th> <th>備註</th> </tr> </thead> <tbody> <tr> <td>All</td> <td>$\emptyset < 0.2\text{mm};$</td> <td colspan="3">不計數</td> <td></td> </tr> <tr> <td>$<6''$</td> <td>$0.2 \leq \emptyset \leq 0.3\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$</td> <td>$N \leq 1$</td> <td>$N \leq 2$</td> <td>$N \leq 3$</td> <td></td> </tr> <tr> <td>$6\sim 8''$</td> <td>$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$</td> <td>$N \leq 2$</td> <td>$N \leq 3$</td> <td>$N \leq 5$</td> <td>$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 1 \text{ is allowed at outer.}$</td> </tr> <tr> <td>$8.1''\sim 10.1''$</td> <td>$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$</td> <td>$N \leq 2$</td> <td>$N \leq 5$</td> <td>$N \leq 7$</td> <td>$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 2 \text{ is allowed at outer.}$</td> </tr> <tr> <td>$10.2''\sim 15''$</td> <td>$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$</td> <td>$N \leq 5$</td> <td>$N \leq 10$</td> <td>$N \leq 15$</td> <td>$(0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 5 \text{ is allowed at outer.})$</td> </tr> </tbody> </table> <p>Note3: Inactive area $D < 0.2\text{mm}$ is not counted without appearance observation.</p> <p>Remark:</p> <p>Effective area is from the POL cutting side to 0.5mm of inside. This is no count area. Other part is effective area. In no count area, any defect can ignore. In effective area, have to judge from above-mentioned specification.</p> 	尺寸	缺圖	中心 Center	外圍 Outer	總數 Total	備註	All	$\emptyset < 0.2\text{mm};$	不計數				$<6''$	$0.2 \leq \emptyset \leq 0.3\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 1$	$N \leq 2$	$N \leq 3$		$6\sim 8''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 2$	$N \leq 3$	$N \leq 5$	$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 1 \text{ is allowed at outer.}$	$8.1''\sim 10.1''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 2$	$N \leq 5$	$N \leq 7$	$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 2 \text{ is allowed at outer.}$	$10.2''\sim 15''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 5$	$N \leq 10$	$N \leq 15$	$(0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 5 \text{ is allowed at outer.})$
尺寸	缺圖	中心 Center	外圍 Outer	總數 Total	備註																																	
All	$\emptyset < 0.2\text{mm};$	不計數																																				
$<6''$	$0.2 \leq \emptyset \leq 0.3\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 1$	$N \leq 2$	$N \leq 3$																																		
$6\sim 8''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 2$	$N \leq 3$	$N \leq 5$	$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 1 \text{ is allowed at outer.}$																																	
$8.1''\sim 10.1''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 2$	$N \leq 5$	$N \leq 7$	$0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 2 \text{ is allowed at outer.}$																																	
$10.2''\sim 15''$	$0.2 \leq \emptyset \leq 0.5\text{mm};$ $L \leq 1\text{mm}, W \leq 0.1\text{mm}$	$N \leq 5$	$N \leq 10$	$N \leq 15$	$(0.4 \leq \emptyset \leq 0.5\text{mm}, N \leq 5 \text{ is allowed at outer.})$																																	

																				
04	Black and White line Scratch Foreign material (Line type) (Minor defect)	<table border="1" data-bbox="568 842 1187 1145"> <thead> <tr> <th>Length</th><th>Width</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>/</td><td>$W \leq 0.03$</td><td>Ignore</td></tr> <tr> <td>$L \leq 2.5$</td><td>$0.03 < W \leq 0.05$</td><td>3</td></tr> <tr> <td>$L \leq 2.5$</td><td>$0.05 < W \leq 0.10$</td><td>2</td></tr> <tr> <td>/</td><td>$0.1 < W$</td><td>0</td></tr> <tr> <td align="center" colspan="2">Total</td><td>3</td></tr> </tbody> </table> <p>Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.</p>	Length	Width	Acc. Qty	/	$W \leq 0.03$	Ignore	$L \leq 2.5$	$0.03 < W \leq 0.05$	3	$L \leq 2.5$	$0.05 < W \leq 0.10$	2	/	$0.1 < W$	0	Total		3
Length	Width	Acc. Qty																		
/	$W \leq 0.03$	Ignore																		
$L \leq 2.5$	$0.03 < W \leq 0.05$	3																		
$L \leq 2.5$	$0.05 < W \leq 0.10$	2																		
/	$0.1 < W$	0																		
Total		3																		
05	Glass Crack (Minor defect)	 <p>Crack is potential to enlarge, any type is not allowed.</p>																		

06	<p>Glass Chipping Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>3</td> </tr> <tr> <td colspan="2">$a < \text{Glass Thickness}$</td></tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	3	$a < \text{Glass Thickness}$			
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	3											
$a < \text{Glass Thickness}$												
07	<p>Glass Chipping Rear of Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2">$a < \text{Glass Thickness}$</td></tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
08	<p>Glass Chipping Except Pad Area: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c > 3.0, b < 1.0$</td> <td>1</td> </tr> <tr> <td>$c < 3.0, b < 1.0$</td> <td>2</td> </tr> <tr> <td>$c < 3.0, b < 0.5$</td> <td>4</td> </tr> <tr> <td colspan="2">$a < \text{Glass Thickness}$</td></tr> </tbody> </table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
09	<p>Glass Corner Chipping: (Minor defect)</p> 	<table border="1"> <thead> <tr> <th>Length and Width</th> <th>Acc. Qty</th> </tr> </thead> <tbody> <tr> <td>$c < 3.0, b < 3.0$</td> <td>Ignore</td> </tr> <tr> <td colspan="2">$a < \text{Glass Thickness}$</td></tr> </tbody> </table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	$a < \text{Glass Thickness}$					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
$a < \text{Glass Thickness}$												

	Glass Burr: (Minor defect)	<table border="1"> <thead> <tr> <th>Length</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>$F < 1.0$</td><td>Ignore</td></tr> </tbody> </table> <p>Glass burr don't affect assemble and module dimension.</p>	Length	Acc. Qty	$F < 1.0$	Ignore				
Length	Acc. Qty									
$F < 1.0$	Ignore									
10										
11	FPC Defect: (Minor defect)	<p>11.1 Dent, pinhole width $a < w/3$. (w: circuitry width.)</p> <p>11.2 Open circuit is unacceptable.</p> <p>11.3 No oxidation, contamination and distortion.</p>								
12	Bubble on Polarizer (Minor defect)	<table border="1"> <thead> <tr> <th>Diameter</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>$\phi \leq 0.20$</td><td>Ignore</td></tr> <tr> <td>$0.20 < \phi \leq 0.30$</td><td>4</td></tr> <tr> <td>$0.30 < \phi$</td><td>None</td></tr> </tbody> </table>	Diameter	Acc. Qty	$\phi \leq 0.20$	Ignore	$0.20 < \phi \leq 0.30$	4	$0.30 < \phi$	None
Diameter	Acc. Qty									
$\phi \leq 0.20$	Ignore									
$0.20 < \phi \leq 0.30$	4									
$0.30 < \phi$	None									
13	Dent on Polarizer (Minor defect)	<table border="1"> <thead> <tr> <th>Diameter</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>$\phi \leq 0.20$</td><td>Ignore</td></tr> <tr> <td>$0.20 < \phi \leq 0.30$</td><td>4</td></tr> <tr> <td>$0.30 < \phi$</td><td>None</td></tr> </tbody> </table>	Diameter	Acc. Qty	$\phi \leq 0.20$	Ignore	$0.20 < \phi \leq 0.30$	4	$0.30 < \phi$	None
Diameter	Acc. Qty									
$\phi \leq 0.20$	Ignore									
$0.20 < \phi \leq 0.30$	4									
$0.30 < \phi$	None									
14	Bezel	<p>14.1 No rust, distortion on the Bezel.</p> <p>14.2 No visible fingerprints, stains or other contamination.</p>								

15	Touch Panel	D: Diameter W: width L: length 15.1 Spot: D<0.25 is acceptable $0.25 \leq D \leq 0.4$ 2dots are acceptable and the distance between defects should more than 10 mm. D>0.4 is unacceptable 15.2 Dent: D>0.40 is unacceptable 15.3 Scratch: W≤0.03, L≤10 is acceptable, $0.03 < W \leq 0.10, L \leq 10$ is acceptable Distance between 2 defects should more than 10 mm. W>0.10 is unacceptable.
16	PCB	16.1 No distortion or contamination on PCB terminals. 16.2 All components on PCB must same as documented on the BOM/component layout. 16.3 Follow IPC-A-600F.
17	Soldering	Follow IPC-A-610C standard
18	Electrical Defect (Major defect)	The below defects must be rejected. 18.1 Missing vertical / horizontal segment, 18.2 Abnormal Display. 18.3 No function or no display. 18.4 Current exceeds product specifications. 18.5 LCD viewing angle defect. 18.6 No Backlight. 18.7 Dark Backlight. 18.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

10.7. Classification of Defects

- 10.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.
- 10.7.2. Two minor defects are equal to one major in lot sampling inspection.

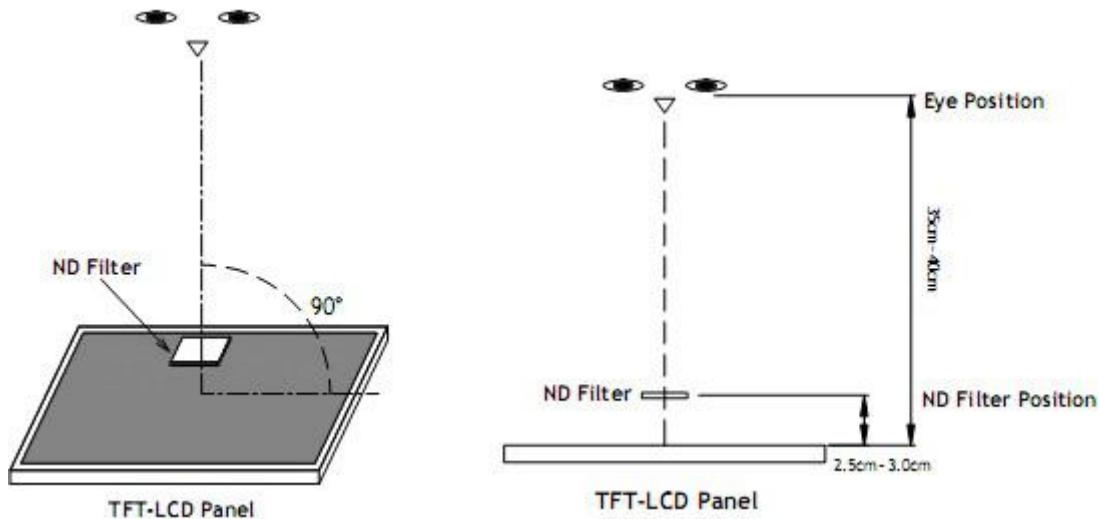
10.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

10.9. Packing

- 10.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.
- 10.9.2. Modules inside package box should have compliant mark.
- 10.9.3. All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is $350\text{mm} \pm 50\text{mm}$.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is $350\text{mm} \pm 50\text{mm}$.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

11. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	70°C, 96Hrs	2	GB/T2423.2 -2008
2	Low Temperature Operating	-20°C, 96Hrs	2	GB/T2423.1 -2008
3	High Humidity	50°C, 90%RH, 96Hrs	2	GB/T2423.3 -2006
4	High Temperature Storage	80°C, 96Hrs	2	GB/T2423.2 -2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1 -2008
6	Thermal Cycling Test	-20°C, 60min~ 70°C, 60min, 20 cycles.	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air: $\pm 8KV$ 150pF/330 Ω 5 times Contact: $\pm 4KV$ 150pF/330 Ω 5 times	2	GB/T17626.2 -2006
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No deflection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

12. Precautions and Warranty

12.1.Safety

- 12.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 12.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

12.2.Handling

- 12.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 12.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

12.3.Storage

- 12.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 12.3.2. Strong light exposure causes degradation of polarizer and color filter.

12.4.Metal Pin (Apply to Products with Metal Pins)

12.4.1. Pins of LCD and Backlight

- 12.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering
- 12.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

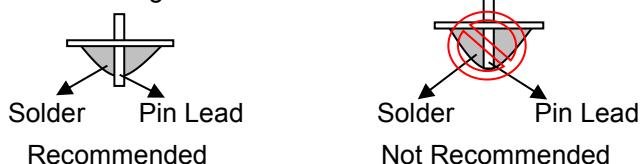
Maximum Solder Temperature: 370 °C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20 °C

Typical Soldering Time: ≤3s

12.4.1.3. Solder Wetting



12.4.2. Pins of EL

- 12.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.
- 12.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.
- 12.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270~290 °C

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

12.4.2.4. No horizontal press on the EL leads during soldering.

12.4.2.5. 180° bend EL leads three times is not allowed.

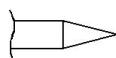
12.4.2.6. Solder Wetting



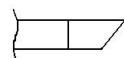
Recommended

Not Recommended

12.4.2.7. The type of the solder iron:

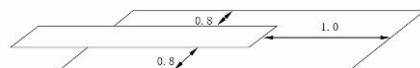


Recommended



Not Recommended

12.4.2.8. Solder Pad



12.5.Operation

- 12.5.1. Do not drive LCD with DC voltage
- 12.5.2. Response time will increase below lower temperature
- 12.5.3. Display may change color with different temperature
- 12.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear "fractured".
- 12.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 12.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 12.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 12.5.8. Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it may develop image sticking due to the TFT structure.

12.6.Static Electricity

- 12.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 12.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 12.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

12.7.Limited Warranty

- 12.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 12.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 12.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

13. Packaging

TBD

14. Outline Drawing

